# LNJ826W83RA

### Surface Mounting Chip LED

**UTSS Type** 

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	$P_{D}$	45	mW	
Forward current	$I_{\mathrm{F}}$	20	mA	
Pulse forward current *	$I_{FP}$	60	mA	
Reverse voltage	V <sub>R</sub>	4	V	
Operating ambient temperature	T <sub>opr</sub>	-30 to +85	°C	
Storage temperature	T <sub>stg</sub>	-40 to +100	°C	

Note) \*: The conditon of I<sub>FP</sub> is duty 10%, pulse width 10 ms.

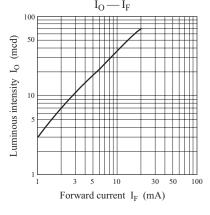
#### ■ Lighting Color

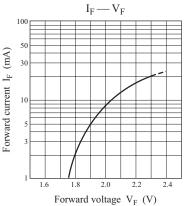
• Orange

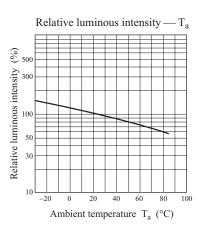
#### ■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

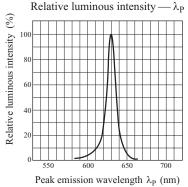
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I <sub>O</sub>	$I_F = 5 \text{ mA}$	11.5	19.0	47.3	mcd
Reverse current	$I_R$	$V_R = 4 V$			100	μΑ
Forward voltage	V <sub>F</sub>	$I_F = 5 \text{ mA}$		1.9	2.1	V
Peak emission wavelength	$\lambda_{\mathrm{P}}$	$I_F = 5 \text{ mA}$		630		nm
Dominant emission wavelength	$\lambda_{\mathrm{d}}$	$I_F = 5 \text{ mA}$	615	620	627	nm
Spectral half band width	Δλ	$I_F = 5 \text{ mA}$		13		nm

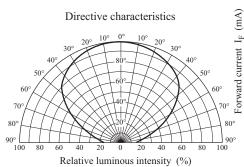
Note) Be careful of the product destruction by static electricity.

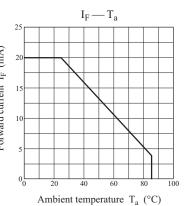




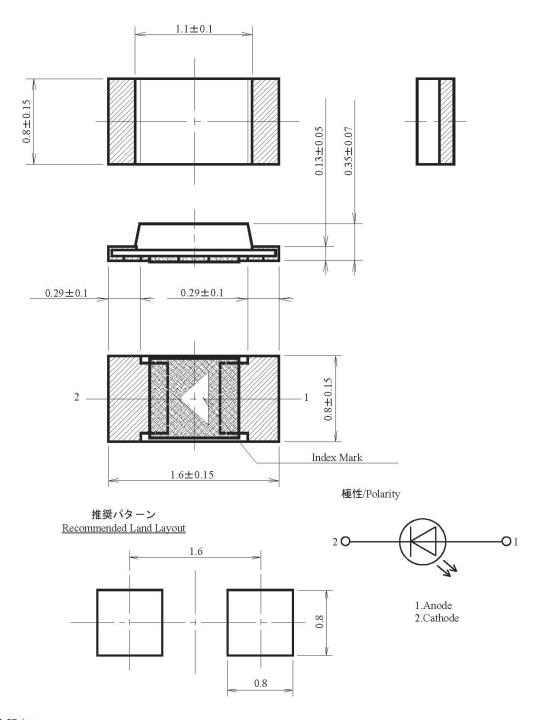








#### ■ Package (Unit: mm)



#### 注記/Notes

1.パッケージ寸法については電極バリを含まない。

Measurement of the package doesn't include electrode projection.

2.単位:mm/Unit:mm

2 Ver. DEK

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